1. Scope

The present specifications shall apply to an RN4Z.

2. Outline

	Туре	Silicon Diode					
	Structure	Resin Molded					
	Applications	High Frequency Rectification					
3. F	Flammability UL94V-0(Equivalent)						
	Flammability UL94V-0(Equivalent)						
	mendedte						
	Hot Recommended for New Y						

3. Flammability

4. Absolute maximum ratings

No.	Item	Symbol	Unit	Rating	Conditions
1	Transient Peak Reverse Voltage	V _{RSM}	V	200	
2	Peak Reverse Voltage	V _{RM}	V	200	
3	Average Forward Current	I _{F(AV)}	А	3.5	Refer to Derating of 7
4	Peak Surge Forward Current	I _{FSM}	А	120	10msec. Half sinewave, one shot
5	I ² t Limiting Value	I ² t	A ² s	72	1 msec $\leq t \leq 10$ msec
6	Junction Temperature	Tj	°C	-40~+150	
7	Storage Temperature	T _{stg}	°C	-40~+150	5

5. Electrical characteristics (Ta= 25° C , unless otherwise specified)

No.	Item	Symbol	Unit	Value	Conditions	
1	Forward Voltage Drop	\mathbf{V}_{F}	V	0.92 max.	I _F =3.5A	
2	Reverse Leakage Current	I _R	uA	50 max.	$V_R = V_{RM}$	
3	Reverse Leakage Current Under High Temperature	H•I _R	mA	6.0 max.	$V_R = V_{RM}, T_j = 150^{\circ}C$	
4	Reverse Recovery Time	t _{rr} l	ns	100 max.	I _F =I _{RP} =500mA 90% Recovery point,	
4	Reverse Recovery Time	t _{rr} 2	ns	50 max.	I _F =500mA, I _{RP} =1A 75% Recovery point,	
5	Thermal Resistance	R _{th(j-l)}	°C/W	8.0 max.	Between Junction and Lead	
AotRec						

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6. Characteristics





8. Package information

8-1 Package type, physical dimensions and material



RN4Z

10.	0. Reliability						
No	. Item	Rating	Conditions				
1	Thermal Fatigue Test	5000 cycles	∠Tj=100°C				
2	High Temperature Reverse Bias Test	1000 hours	Ta=120°C, $V_R=V_{RM}$ (Half sine wave)				
3	Humidity Reverse Bias Test	500 hours	Ta=85°C, R.H.=85%, $V_R = V_{RM} \times 0.8(D.C.)$				
4	High Temperature Storage Test	1000 hours	Ta=150°C				
5	Moisture Resistance Test	1000 hours Ta=85°C, 85%R.H.					
6	Thermal Shock Test	100 cycles	Ice-water(5min.) ~ R.T.(20sec.) ~ Boiling-water(5min.)				
7	Temperature Cycle Test	100 cycles	-40°C(30min.)~+150°C(30min.)				
8	Pressure Cooker Test	48 hours	2.03×10^{5} Pa, 100%R.H., Unsaturated equipment				
		10 sec.	$260\pm5^{\circ}$ C, Dipping up to 1.5mm form case				
9	Resistance to Soldering Heat Test	3.5 sec.	380±5℃, Using soldering iron				
10	Solder ability Test	95%	245±5°C, 5±0.5sec., Using rosin flux				
11	Lead Bend Test	2 cycles					
12	Lead Pull Test	10 sec.	Apply EIAJ ED 4701/400				
13	Lead Twist Test	2 times					
14	Drop Test	10 times	Naturally drop from 1m height on maple plate				

11. Acceptance Criteria

(1)Item No.1~9 The product shall meet the electrical specifications in paragraph 5 satisfy 1 and 2 after being exposed to normal temperature for less than

24 hours in 2 hours or more

(2)Item No.10 (3)Item No.11~14 The product shall meet the rating. There shall be no trouble in testing and the electrical characteristics in paragraph 5 satisfy 1 and 2.

12. Cautions and warnings

- Application and operation examples described in this document are quoted for the sole purpose of reference for the use of the products herein and Sanken can assume no responsibility for any infringement of industrial property rights, intellectual property rights or any other rights of Sanken or any third party which may result from its use.
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In addition, it should be noted that since power devices or IC's including power devices have large self-heating value, the degree of derating of junction temperature (Tj) affects the reliability significantly.

- When using the products specified herein by either (i) combining other products or materials therewith or (ii) physically, chemically or otherwise processing or treating the products, please duly consider all possible risks that may result from all such uses in advance and proceed therewith at your own responsibility.
- Anti radioactive ray design is not considered for the products listed herein.

must be taken into consideration

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